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February 2011

# NC7SZ04 TinyLogic<sup>®</sup> UHS Inverter

#### **Features**

- Ultra-High Speed: t<sub>PD</sub> 2.4ns (Typical) into 50pF at 5V V<sub>CC</sub>
- High Output Drive: ±24mA at 3V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65V to 5.5V
- Matches Performance of LCX when Operated at 3.3V V<sub>CC</sub>
- Power Down High Impedance Inputs/Outputs
- Over-Voltage Tolerance Inputs Facilitate 5V to 3V Translation
- Proprietary Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak<sup>™</sup> Packages
- Space-Saving SOT23 and SC70 Packages

## Description

The NC7SZ04 is a single inverter from Fairchild's Ultra-High Speed (UHS) series of TinyLogic®. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a broad  $V_{\rm CC}$  operating range. The device is specified to operate over the 1.65V to 5.5V  $V_{\rm CC}$  operating range. The inputs and output are high-impedance when  $V_{\rm CC}$  is 0V. Inputs tolerate voltages up to 6V, independent of  $V_{\rm CC}$  operating voltage.

### **Related Resources**

 MS-503 — Family Characteristics TinyLogic<sup>®</sup> HS/HST and UHS Series

# **Ordering Information**

Part Number	Top Mark	Package	Packing Method
NC7SZ04M5X	7Z04	5-Lead SOT23, JEDEC MO-178 1.6mm	3000 Units on Tape & Reel
NC7SZ04P5X	Z04	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7SZ04L6X	CC	6-Lead MicroPak™, 1.00mm Wide	5000 Units on Tape & Reel
NC7SZ04FHX	CC	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	5000 Units on Tape & Reel

# **Connection Diagrams**

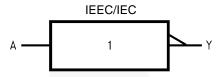
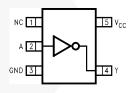


Figure 1. Logic Symbol

# **Pin Configurations**



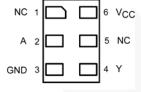


Figure 2. SC70 and SOT23 (Top View)

Figure 3. MicroPak™ (Top Through View)

## **Pin Definitions**

Pin # SC70 / SOT23	Pin # MicroPak™	Name	Description
1	1,5	NC	No Connect
2	2	A	Input
3	3	GND	Ground
4	4	Υ	Output
5	6	6 V <sub>CC</sub> Supply Voltage	

# **Function Table**

Y = /A

Inputs	Output
Α	Y
L	Н
Н	L

H = HIGH Logic Level

L = LOW Logic Level

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Para	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage		-0.5	6.0	V
V <sub>IN</sub>	DC Input Voltage		-0.5	6.0	V
V <sub>OUT</sub>	DC Output Voltage		-0.5	6.0	V
	DC Input Diode Current	V <sub>IN</sub> < -0.5V		-50	- mA
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> > 6.0V		+20	ina ina
	DC Output Diodo Current	V <sub>OUT</sub> < -0.5V		-50	mA
I <sub>OK</sub>	DC Output Diode Current	$V_{OUT} > 6V, V_{CC} = GND$		+20	IIIA
I <sub>OUT</sub>	DC Output Current			±50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current			±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
$T_J$	Junction Temperature Under B	ias		+150	°C
T <sub>L</sub>	Junction Lead Temperature (So	oldering, 10 Seconds)		+260	°C
A		SOT-23		200	
В	Dower Dissipation at 1959C	SC70-5		150	\/
$P_D$	Power Dissipation at +85°C	MicroPak™-6	1	130	- mW
		MicroPak2™-6		120	
ESD	Human Body Model, JEDEC:JESD22-A114			4000	V
ESD	Charge Device Model, JEDEC:	JESD22-C101		2000	V

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
V	Supply Voltage Operating		1.65	5.50		
V <sub>CC</sub>	Supply Voltage Data Retention		1.5	5.5	V	
V <sub>IN</sub>	Input Voltage		0	5.5	V	
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V	
T <sub>A</sub>	Operating Temperature		-40	+85	°C	
		V <sub>CC</sub> at 1.8V, 2.5V ±0.2V	0	20	$\langle \cdot \rangle$	
$t_r$ , $t_f$	Input Rise and Fall Times	V <sub>CC</sub> at 3.3V ± 0.3V	0	10	ns/V	
		V <sub>CC</sub> at 5.0V ± 0.5V	0	5		
		SOT-23		300		
	The survey Designation of	SC70-5		425	00044	
$\theta_{\sf JA}$	Thermal Resistance	MicroPak™-6		500	°C/W	
		MicroPak2™-6		560		

#### Note:

1. Unused inputs must be held HIGH or LOW. They may not float.

# **DC Electrical Characteristics**

		.,	V Constitions	1	T <sub>A</sub> =25°C			T <sub>A</sub> =-40 to 85°C	
Symbol	Parameter	V <sub>cc</sub>	Conditions	Min.	Тур.	Max.	Min.	Max.	Units
\ /	HIGH Level Input	1.65 to 1.95		0.75V <sub>CC</sub>			0.75V <sub>CC</sub>		
$V_{IH}$	Voltage	2.30 to 5.50		0.70V <sub>CC</sub>			0.70V <sub>CC</sub>		V
1/	LOW Level Input	1.65 to 1.95				0.25V <sub>CC</sub>		0.25V <sub>CC</sub>	V
$V_{IL}$	Voltage	2.30 to 5.50				0.30V <sub>CC</sub>		0.30V <sub>CC</sub>	V
		1.65		1.55	1.65				
		1.80		1.70	1.80		1.70		
		2.30	$V_{IN}=V_{IL}$ , $I_{OH}=-100\mu A$	2.20	2.30		2.20		
		3.00		2.90	3.00		2.90		
.,	HIGH Level	4.50		4.40	4.50		4.40		V
$V_{OH}$	Output Voltage	1.65	I <sub>OH</sub> =-4mA	1.29	1.52		1.29		
		2.30	I <sub>OH</sub> =-8mA	1.90	2.15	/	1.90		
		3.00	I <sub>OH</sub> =-16mA	2.40	2.80		2.40		
		3.00	I <sub>OH</sub> =-24mA	2.30	2.68		2.30		
		4.50	I <sub>OH</sub> =-32mA	3.80	4.20		3.80		
		1.65	.65		0.00	0.10		0.10	
		1.80			0.00	0.10		0.10	
		2.30	V <sub>IN</sub> =V <sub>IH</sub> , I <sub>OL</sub> =100μA		0.00	0.10		0.10	
		3.00			0.00	0.10		0.10	
.,	LOW Level Output	4.50			0.00	0.10		0.10	V
$V_{OL}$	Voltage	1.65	I <sub>OL</sub> =4mA		0.80	0.24		0.24	
		2.30	I <sub>OL</sub> =8mA		0.10	0.30		0.30	
		3.00	I <sub>OL</sub> =16mA		0.15	0.40		0.40	
		3.00	I <sub>OL</sub> =24mA		0.22	0.55		0.55	
		4.50	I <sub>OL</sub> =32mA		0.22	0.55		0.55	
I <sub>IN</sub>	Input Leakage Current	0 to 5.5	$0 \le V_{IN} \le 5.5V$			±1		±10	μΑ
I <sub>OFF</sub>	Power Off Leakage Current	0	V <sub>IN</sub> or V <sub>OUT</sub> =5.5V			1	A	10	μA
I <sub>cc</sub>	Quiescent Supply Current	1.65 to 5.50	V <sub>IN</sub> =5.5V, GND			2.0		20	μΑ

## **AC Electrical Characteristics**

Cumbal	Parameter	V	V <sub>cc</sub> Conditions	T <sub>A</sub> =25°C		T <sub>A</sub> =-40 to 85°C		Units	Figure	
Symbol	Parameter	V <sub>cc</sub>	Conditions	Min.	Тур.	Max.	Min.	Max.	Units	Figure
		1.65		2.0	5.3	11.4	2.0	12.0		
		1.80		2.0	4.4	9.5	2.0	10.0		
		$2.50 \pm 0.20$	$C_L$ =15pF, $R_L$ =1M $\Omega$	0.8	2.9	6.5	0.8	7.0	ns	
$t_{PLH}$ , $t_{PHL}$	Propagation Delay	$3.30 \pm 0.30$		0.5	2.1	4.5	0.5	4.7		Figure 4 Figure 5
		5.00 ± 0.50		0.5	1.8	3.9	0.5	4.1		940
		$3.30 \pm 0.30$	C <sub>L</sub> =50pF,	1.5	2.9	5.0	1.5	5.2		
		5.00 ± 0.50	R <sub>L</sub> =500Ω	0.8	2.4	4.3	0.8	4.5		
C <sub>IN</sub>	Input Capacitance	0.00			4				pF	
	Power Dissipation	3.30			20				,r	Figure 6
C <sub>PD</sub>	Capacitance <sup>(2)</sup>	5.00			26				pF	Figure 6

#### Note:

2.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption ( $I_{CCD}$ ) at no output lading and operating at 50% duty cycle.  $C_{PD}$  is related to  $I_{CCD}$  dynamic operating current by the expression:  $I_{CCD} = (C_{PD})(V_{CC})(f_{IN}) + (I_{CC} \text{static})$ .

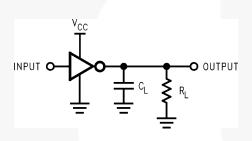


Figure 4. AC Test Circuit

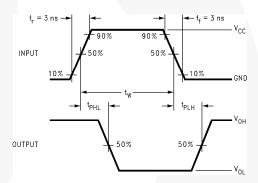
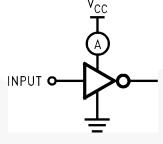


Figure 5. AC Waveforms



## Note:

3. Input=AC Waveform; t<sub>r</sub>=t<sub>f</sub>=1.8ns; PRR=10MHz; Duty Cycle=50%.

Figure 6. I<sub>CCD</sub> Test Circuit

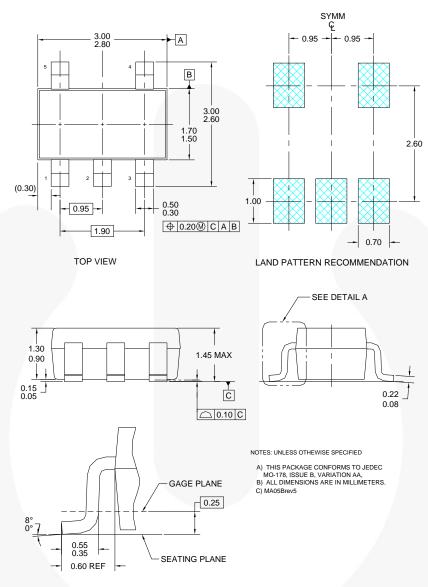


Figure 7. 5-Lead SOT23, JEDEC MO-178 1.6mm

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## **Tape and Reel Specification**

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Package Designator	Tape Section	<b>Cavity Number</b>	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
M5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

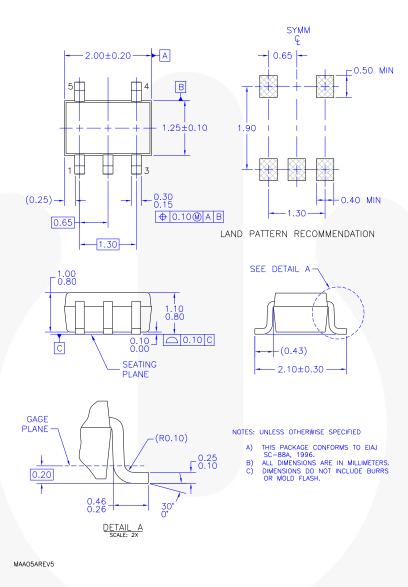


Figure 8. 5-Lead, SC70, EIAJ SC-88a, 1.25mm Wide

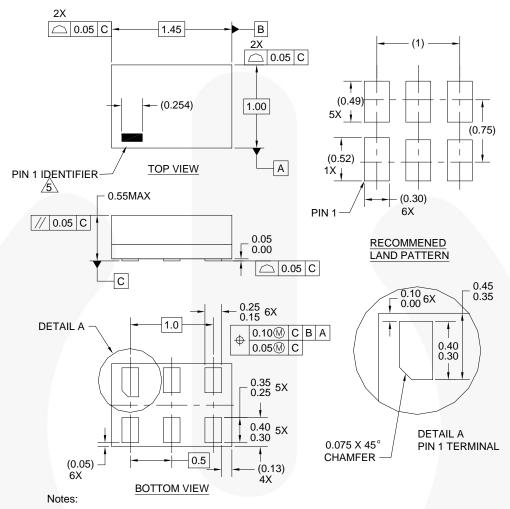
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Package Designator	Tape Section	<b>Cavity Number</b>	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



- 1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994
- 4. FILENAME AND REVISION: MAC06AREV4
- 5. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY

OTHER LINE IN THE MARK CODE LAYOUT.

Figure 9. 6-Lead, MicroPak™, 1.0mm Wide

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Package Designator	Tape Section	<b>Cavity Number</b>	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

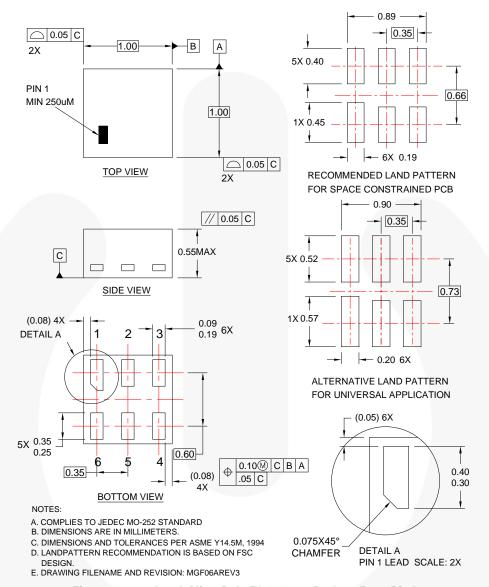


Figure 10. 6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch

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#### Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications: http://www.fairchildsemi.com/packaging/MicroPAK2 6L tr.pdf.

Package Designator	Tape Section	Tape Section Cavity Number		Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
FHX	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed





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